

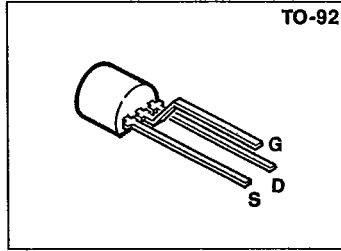
T-27-25

SIPMOS® Small-Signal Transistor

BS 107

$V_{DS} = 200\text{ V}$   
 $I_D = 0.13\text{ A}$   
 $R_{DS(on)} = 26\ \Omega$

- N channel
- Enhancement mode
- Package: TO-92<sup>1)</sup>



Type	Ordering code for version on tape	Ordering code for version in bulk
BS 107	Q67000-S078	Q67000-S060

Maximum Ratings

Parameter	Symbol	Values	Unit
Drain-source voltage	$V_{DS}$	200	V
Drain-gate voltage, $R_{GS} = 20\text{ k}\Omega$	$V_{DGR}$	200	
Gate-source voltage	$V_{GS}$	$\pm 10$	
Gate-source peak voltage, aperiodic	$V_{gs}$	$\pm 20$	
Continuous drain current, $T_A = 31\text{ }^\circ\text{C}$	$I_D$	0.13	A
Pulsed drain current, $T_A = 25\text{ }^\circ\text{C}$	$I_{D\text{ puls}}$	0.52	
Operating and storage temperature range	$T_j$	- 55 ... + 150	$^\circ\text{C}$
	$T_{stg}$		
Thermal resistance chip - ambient (without heat sink)	$R_{thJA}$	$\leq 125$	K/W
Max. power dissipation, $T_A = 25\text{ }^\circ\text{C}$	$P_{tot}$	1.0	W
DIN humidity category, DIN 40040	-	E	-
IEC climatic category, DIN IEC 68-1	-	55/150/56	-

<sup>1)</sup> See chapter Package Outlines.

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**Electrical Characteristics**

at  $T_j = 25\text{ }^\circ\text{C}$ , unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>Static characteristics</b>					
Drain-source breakdown voltage $V_{GS} = 0, I_D = 0.25\text{ mA}$	$V_{(BR)DSS}$	200	-	-	V
Gate threshold voltage $V_{GS} = V_{DS}, I_D = 1\text{ mA}$	$V_{GS(th)}$	0.8	1.5	2.0	
Zero gate voltage drain current $V_{DS} = 200\text{ V}, V_{GS} = 0$ $T_j = 25\text{ }^\circ\text{C}$ $T_j = 125\text{ }^\circ\text{C}$	$I_{DSS}$	-	1	15	$\mu\text{A}$
		-	2	60	
$V_{DS} = 130\text{ V}, V_{GS} = 0$ $T_j = 25\text{ }^\circ\text{C}$		-	-	30	nA
$V_{DS} = 70\text{ V}, V_{GS} = 0.2\text{ V}$ $T_j = 25\text{ }^\circ\text{C}$		-	-	1	$\mu\text{A}$
Gate-source leakage current $V_{GS} = 25\text{ V}, V_{DS} = 0$	$I_{GSS}$	-	1	10	nA
Drain-source on-resistance $V_{GS} = 4.5\text{ V}, I_D = 0.12\text{ A}$ $V_{GS} = 2.8\text{ V}, I_D = 0.02\text{ A}$	$R_{DS(on)}$	-	14	26	$\Omega$
		-	14.5	28	

**Dynamic characteristics**

Forward transconductance $V_{DS} \geq 2 \times I_D \times R_{DS(on)max}, I_D = 0.12\text{ A}$	$g_{fs}$	0.06	0.16	-	S	
Input capacitance $V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$	$C_{iss}$	-	60	90	pF	
Output capacitance $V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$		$C_{oss}$	-	8		12
Reverse transfer capacitance $V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$		$C_{rss}$	-	2.5		5.0
Turn-on time $t_{on}$ , ( $t_{on} = t_{d(on)} + t_r$ ) $V_{CC} = 30\text{ V}, V_{GS} = 10\text{ V}, R_{GS} = 50\text{ }\Omega, I_D = 0.24\text{ A}$	$t_{d(on)}$	-	5	8	ns	
	$t_r$	-	8	12		
Turn-off time $t_{off}$ , ( $t_{off} = t_{d(off)} + t_f$ ) $V_{CC} = 30\text{ V}, V_{GS} = 10\text{ V}, R_{GS} = 50\text{ }\Omega, I_D = 0.24\text{ A}$	$t_{d(off)}$	-	12	16		
	$t_f$	-	15	20		

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Electrical Characteristics (continued)  
at  $T_j = 25\text{ }^\circ\text{C}$ , unless otherwise specified.

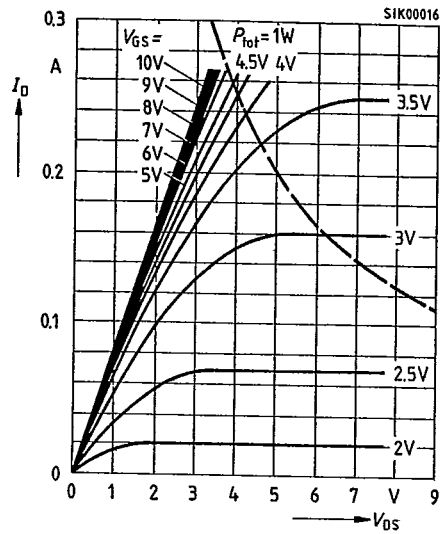
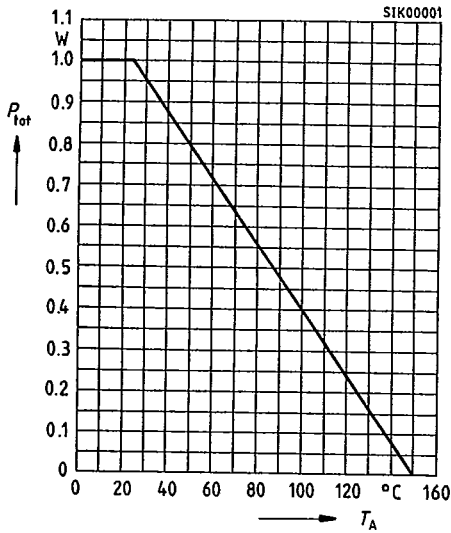
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>Reverse Diode</b>					
Continuous reverse drain current $T_A = 25\text{ }^\circ\text{C}$	$I_S$	-	-	0.13	A
Pulsed reverse drain current $T_A = 25\text{ }^\circ\text{C}$	$I_{SM}$	-	-	0.52	
Diode forward on-voltage $I_F = 0.5\text{ A}$ , $V_{GS} = 0$	$V_{SD}$	-	0.9	1.2	V
Reverse recovery time $V_R = 100\text{ V}$ , $I_F = 0.5\text{ A}$ , $di_F/dt = 100\text{ A}/\mu\text{s}$	$t_{rr}$	-	115	-	ns
Reverse recovery charge $V_R = 100\text{ V}$ , $I_F = 0.5\text{ A}$ , $di_F/dt = 100\text{ A}/\mu\text{s}$	$Q_{rr}$	-	300	-	nC

Characteristics at  $T_j = 25\text{ }^\circ\text{C}$ , unless otherwise specified.

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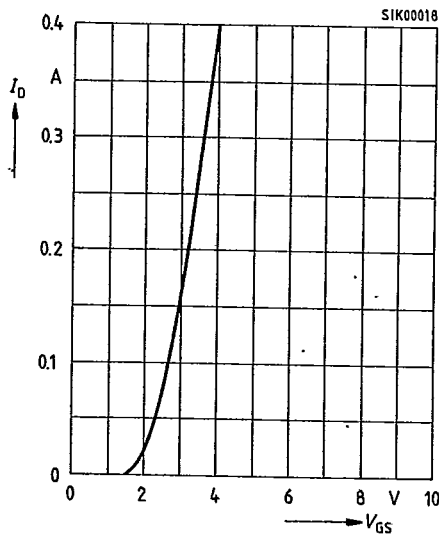
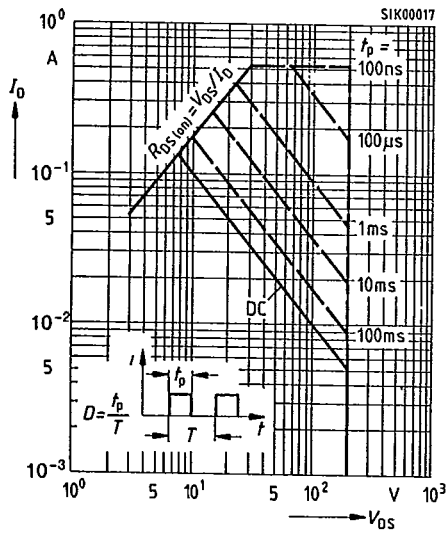
Total power dissipation  $P_{tot} = f(T_A)$

Typ. output characteristics  $I_D = f(V_{DS})$   
parameter:  $t_p = 80\text{ }\mu\text{s}$



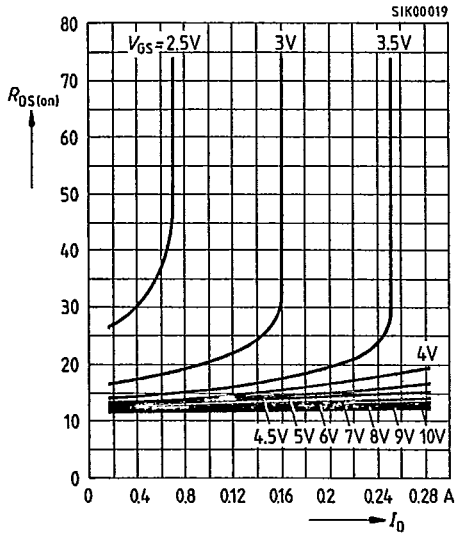
Safe operating area  $I_D = f(V_{DS})$   
parameter:  $D = 0.01$ ,  $T_C = 25\text{ }^\circ\text{C}$

Typ. transfer characteristics  $I_D = f(V_{GS})$   
parameter:  $t_p = 80\text{ }\mu\text{s}$ ,  $V_{DS} = 25\text{ V}$

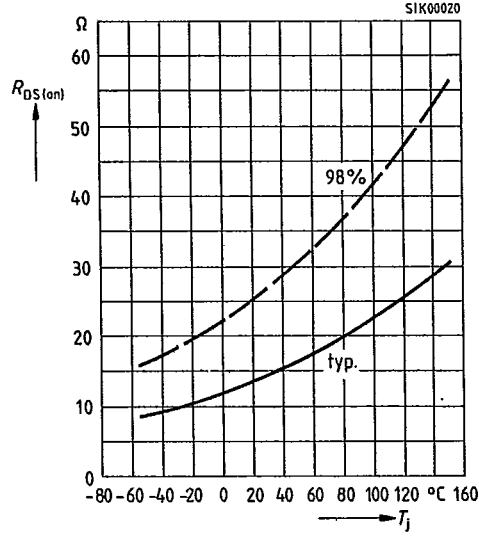


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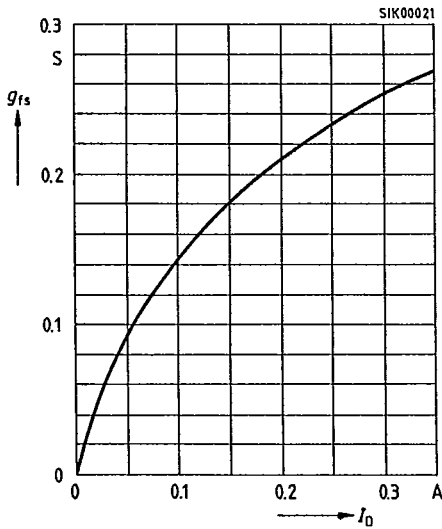
Typ. drain-source on-resistance  
 $R_{DS(on)} = f(I_D)$   
 parameter:  $V_{GS}$



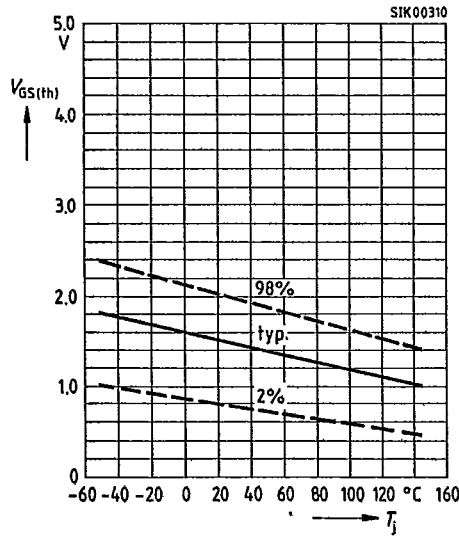
Drain-source on-resistance  
 $R_{DS(on)} = f(T_j)$   
 parameter:  $I_D = 0.12 A, V_{GS} = 4.5 V, (spread)$



Typ. forward transconductance  $g_{fs} = f(I_D)$   
 parameter:  $V_{DS} \geq 2 \times I_D \times R_{DS(on)max.}, t_p = 80 \mu s$

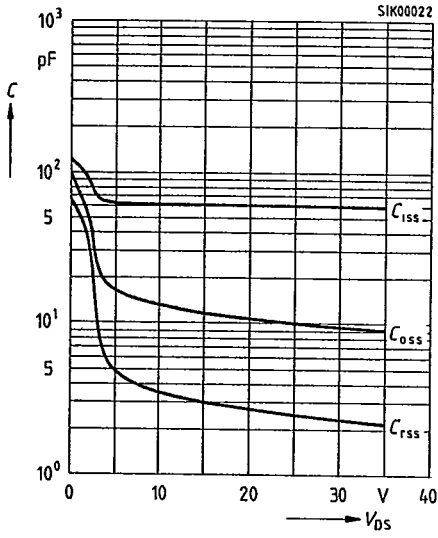


Gate threshold voltage  $V_{GS(th)} = f(T_j)$   
 parameter:  $V_{DS} = V_{GS}, I_D = 1 mA, (spread)$

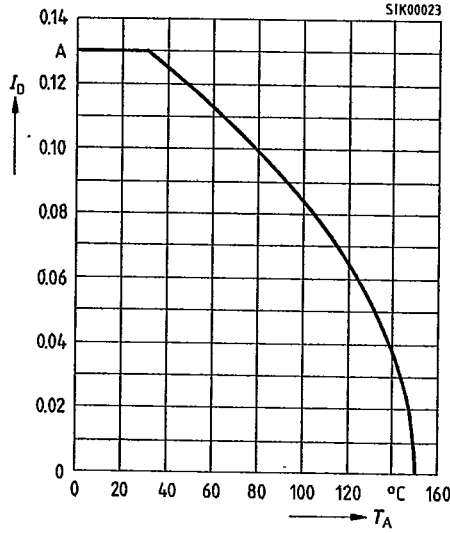


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Typ. capacitances  $C = f(V_{DS})$   
parameter:  $V_{GS} = 0, f = 1 \text{ MHz}$



Drain current  $I_D = f(T_A)$   
parameter:  $V_{GS} \geq 10 \text{ V}$



Forward characteristics of reverse diode

$I_F = f(V_{SD})$   
parameter:  $t_p = 80 \mu\text{s}, T_j$ , (spread)

